

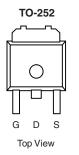
## N-Channel 60-V (D-S) MOSFET

| PRODUCT             | SUMMARY                          |                                 |
|---------------------|----------------------------------|---------------------------------|
| V <sub>DS</sub> (V) | r <sub>DS(on)</sub> (Ω)          | I <sub>D</sub> (A) <sup>a</sup> |
| 60                  | 0.025 at V <sub>GS</sub> = 10 V  | 45                              |
| 30                  | 0.030 at V <sub>GS</sub> = 4.5 V | 40                              |

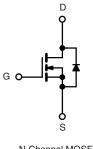
#### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature





Drain Connected to Tab



N-Channel MOSFET

| Parameter  |                         | Symbol                            | Limit          | Unit |  |
|--|-------------------------|-----------------------------------|----------------|------|--|
| Gate-Source Voltage                                  |                         | V <sub>GS</sub>                   | ± 20           | V    |  |
| Continuous Drain Current (T 175 °C)                  | T <sub>C</sub> = 25 °C  | 1-                                | 45             |      |  |
| Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$ | T <sub>C</sub> = 100 °C | I <sub>D</sub>                    | 35             |      |  |
| Pulsed Drain Current                                 |                         | I <sub>DM</sub>                   | 100            | А    |  |
| Continuous Source Current (Diode Conduction)         |                         | ۱ <sub>S</sub>                    | 23             |      |  |
| Avalanche Current                                    |                         | I <sub>AS</sub>                   | 20             |      |  |
| Single Avalanche Energy (Duty Cycle $\leq$ 1 %)      | L = 0.1 mH              | E <sub>AS</sub>                   | 20             | mJ   |  |
| Manimum Danner Diasia atian                          | T <sub>C</sub> = 25 °C  | Р                                 | 100            | w    |  |
| Maximum Power Dissipation                            | T <sub>A</sub> = 25 °C  | P <sub>D</sub>                    | 3 <sup>a</sup> |      |  |
| Operating Junction and Storage Temperature Range     |                         | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 175    | °C   |  |

| THERMAL RESISTANCE RATINGS               |              |                   |         |         |      |
|--|--------------|-------------------|---------|---------|------|
| Parameter                                |              | Symbol            | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient <sup>a</sup> | t ≤ 10 sec   | R <sub>thJA</sub> | 18      | 22      |      |
| Maximum Junction-to-Ambient*             | Steady State | ''thJA            | 40      | 50      | °C/W |
| Maximum Junction-to-Case                 |              | R <sub>thJC</sub> | 3.2     | 4       |      |

Notes:

a. Surface Mounted on 1" x 1" FR4 board, t  $\leq$  10 sec.

| <b>SPECIFICATIONS</b> $T_J = 25$              | °C, unless o         | otherwise noted   |     |                  |       |  |  |
|---|----------------------|---|-----|------------------|-------|--|--|
| Parameter                                     | Symbol               | Test Conditions   | Min | Тур <sup>а</sup> | Мах   | Unit   |  |
| Static  |                      |   |     |                  |       |  |  |
| Drain-Source Breakdown Voltage                | V <sub>(BR)DSS</sub> | $V_{GS} = 0 V, I_D = 250 \mu A$   | 60  |                  |       | V  |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$  | 1.0 | 2.0              | 3.0   | V<br>nA<br>μA<br>A<br>Ω<br>S<br>pF<br>nC<br>ns |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>     | $V_{DS} = 0 V, V_{GS} = \pm 20 V$   |     |                  | ± 100 | nA   |  |
|   |                      | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$   |     |                  | 1     |  |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>     | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$                       |     |                  | 50    | μA   |  |
|   |                      | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$ |     |                  | 250   | 1  |  |
| On-State Drain Current <sup>b</sup>           | I <sub>D(on)</sub>   | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V   | 50  |                  |       | А  |  |
|   |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A   |     | 0.025            |       | Ω  |  |
|   | -                    | $V_{GS}$ = 10 V, I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C                             |     | 0.055            |       |  |  |
| Drain-Source On-State Resistance <sup>b</sup> | r <sub>DS(on)</sub>  | $V_{GS}$ = 10 V, I <sub>D</sub> = 15 A, T <sub>J</sub> = 175 °C                             |     | 0.069            |       |  |  |
|   |                      | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A  |     | 0.030            |       |  |  |
| Forward Transconductance <sup>b</sup>         | 9 <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A   |     | 20               |       | S  |  |
| Dynamic <sup>a</sup>                          |                      |   |     |                  |       |  |  |
| Input Capacitance                             | C <sub>iss</sub>     |   |     | 1500             |       |  |  |
| Output Capacitance                            | C <sub>oss</sub>     | $V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1 MHz  |     | 140              |       | pF   |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>     |   |     | 60               |       |  |  |
| Total Gate Charge <sup>c</sup>                | Qg                   |   |     | 11               | 17    |  |  |
| Gate-Source Charge <sup>c</sup>               | Q <sub>gs</sub>      | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$                          |     | 3                |       | nC   |  |
| Gate-Drain Charge <sup>c</sup>                | Q <sub>gd</sub>      |   |     | 3                |       |  |  |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>   |   |     | 8                | 15    |  |  |
| Rise Time <sup>c</sup>                        | t <sub>r</sub>       | $V_{DD} = 30 \text{ V}, \text{ R}_{L} = 1.3 \Omega$   |     | 15               | 25    |  |  |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>  | $I_D \cong 23$ A, $V_{GEN}$ = 10 V, $R_g$ = 2.5 $\Omega$                                    |     | 30               | 45    | ns   |  |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>       |   |     | 25               | 40    |  |  |
| Source-Drain Diode Ratings and Cha            | aracteristics        | (T <sub>C</sub> = 25 °C)  | -   | ·                |       |  |  |
| Pulsed Current                                | I <sub>SM</sub>      |   |     |                  | 50    | Α  |  |
| Diode Forward Voltage                         | V <sub>SD</sub>      | I <sub>F</sub> = 15 A, V <sub>GS</sub> = 0 V  |     | 1.0              | 1.5   | V  |  |
| Reverse Recovery Time                         | t <sub>rr</sub>      | I <sub>F</sub> = 15 A, di/dt = 100 A/μs   |     | 30               | 60    | ns   |  |

Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. Independent of operating temperature.

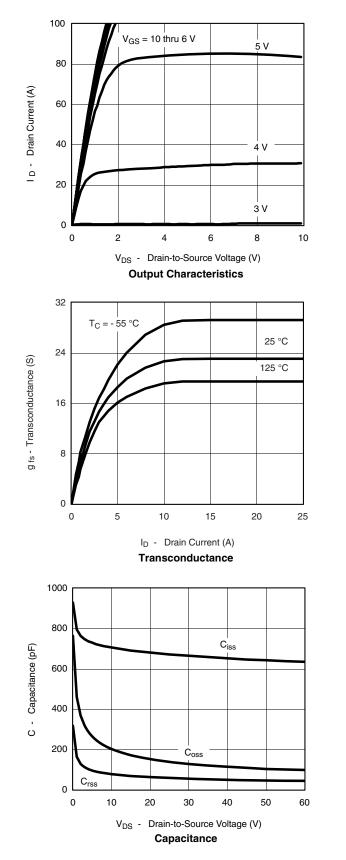
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

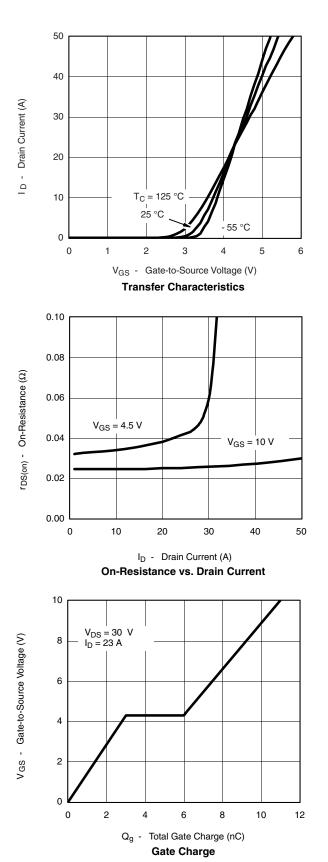
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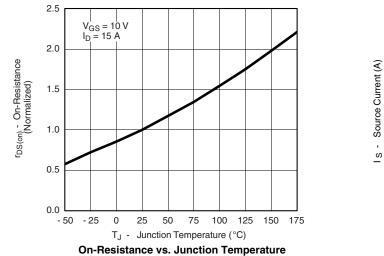
#### TYPICAL CHARACTERISTICS 25 °C unless noted

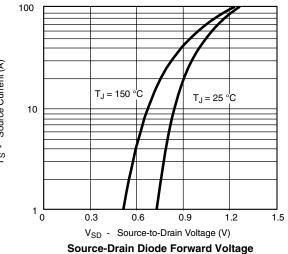






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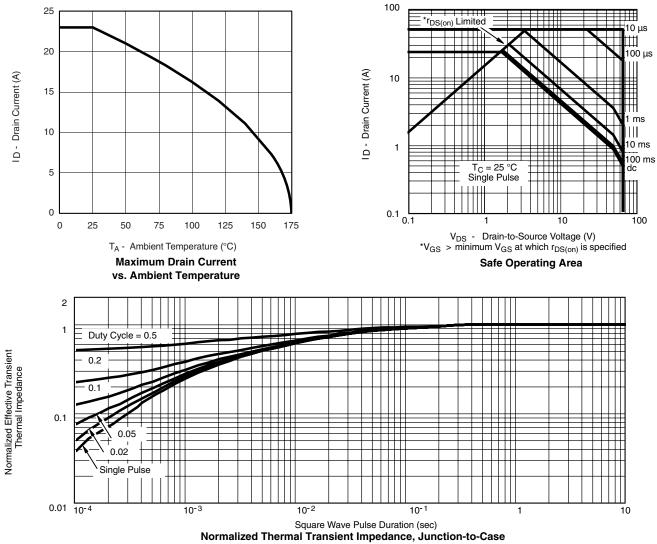




### SUD23N06-31L-GE3

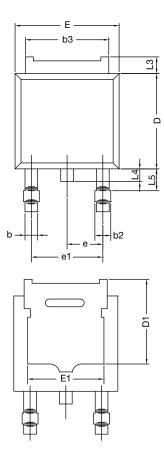


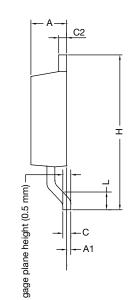
#### **THERMAL RATINGS**





### **TO-252AA CASE OUTLINE**





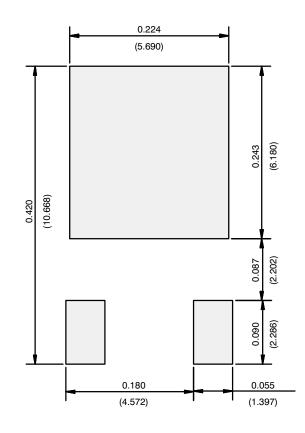
|                       | MILLIN            | IETERS    | INCHES    |       |  |
|-----------------------|-------------------|-----------|-----------|-------|--|
| DIM.                  | MIN.              | MAX.      | MIN.      | MAX.  |  |
| А                     | 2.18              | 2.38      | 0.086     | 0.094 |  |
| A1                    | -                 | 0.127     | -         | 0.005 |  |
| b                     | 0.64              | 0.88      | 0.025     | 0.035 |  |
| b2                    | 0.76              | 1.14      | 0.030     | 0.045 |  |
| b3                    | 4.95              | 5.46      | 0.195     | 0.215 |  |
| С                     | 0.46              | 0.61      | 0.018     | 0.024 |  |
| C2                    | 0.46              | 0.89      | 0.018     | 0.035 |  |
| D                     | 5.97              | 6.22      | 0.235     | 0.245 |  |
| D1                    | 5.21              | -         | 0.205     | -     |  |
| Е                     | 6.35              | 6.73      | 0.250     | 0.265 |  |
| E1                    | 4.32              | -         | 0.170     | -     |  |
| Н                     | 9.40              | 10.41     | 0.370     | 0.410 |  |
| е                     | 2.28              | 2.28 BSC  |           | BSC   |  |
| e1                    | 4.56              | BSC       | 0.180 BSC |       |  |
| L                     | 1.40              | 1.78      | 0.055     | 0.070 |  |
| L3                    | 0.89              | 1.27      | 0.035     | 0.050 |  |
| L4                    | -                 | 1.02      | -         | 0.040 |  |
| L5                    | 1.14              | 1.52      | 0.045     | 0.060 |  |
| ECN: X12-<br>DWG: 534 | 0247-Rev. M,<br>7 | 24-Dec-12 |           |       |  |

Note

• Dimension L3 is for reference only.



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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